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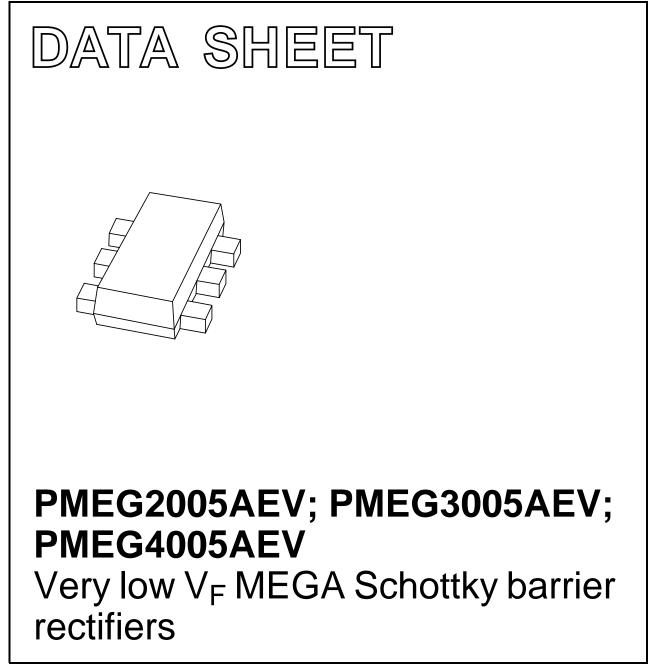
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet

2003 Aug 20



FEATURES

- Very low forward voltage
- High surge current
- Ultra small plastic SMD package.

APPLICATIONS

- Low voltage rectification
- High efficiency DC/DC conversion
- Voltage clamping
- Inverse polarity protection
- Low power consumption applications.

DESCRIPTION

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOT666 ultra small SMD plastic package.

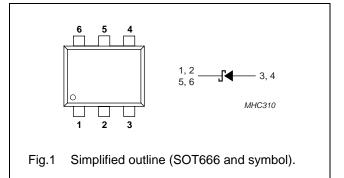
PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
l _F	forward current	0.5	А
V _R	reverse voltage		
	PMEG2005AEV	20	V
	PMEG3005AEV	30	V
	PMEG4005AEV	40	V

PINNING

PIN	DESCRIPTION
1	cathode
2	cathode
3	anode
4	anode
5	cathode
6	cathode



MARKING

TYPE NUMBER	MARKING CODE
PMEG2005AEV	G1
PMEG3005AEV	G2
PMEG4005AEV	G3

RELATED PRODUCTS

TYPE NUMBER	DESCRIPTION	FEATURE
PMEGxx05AEA	0.5 A; 20/30/40 V very low V _F MEGA Schottky rectifier	SOD323 (SC-76) package
PMEG2005EB	0.5 A; 20 V very low V _F MEGA Schottky rectifier	SOD523 (SC-79) package
PMEG2010EA	1 A; 20 V very low V _F MEGA Schottky rectifier	higher forward current

PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage				
	PMEG2005AEV		_	20	V
	PMEG3005AEV		_	30	V
	PMEG4005AEV		_	40	V
I _F	continuous forward current	note 1	_	0.5	A
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.5; \text{ note } 2$	-	3.5	А
I _{FSM}	non-repetitive peak forward current	t _p = 8 ms; square wave; note 2	_	10	А
Tj	junction temperature	note 3	_	150	°C
T _{amb}	operating ambient temperature	note 3	-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Notes

- 1. Refer to SOT666 standard mounting conditions.
- 2. Only valid if pins 3 and 4 are connected in parallel.
- For Schottky barrier diodes thermal runaway has to be considered, as in some applications, the reverse power losses (P_R) are a significant part of the total power losses. Nomograms for determination of the reverse power losses P_R and I_{F(AV)} rating will be available on request.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air; notes 1 and 2	405	K/W
	ambient	in free air; notes 2 and 3	215	K/W
R _{th j-s}	thermal resistance from junction to soldering point	note 4	80	K/W

Notes

- 1. Refer to SOT666 standard mounting conditions.
- 2. For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses. Nomograms for determination of the reverse power losses P_R and $I_{F(AV)}$ rating will be available on request.
- 3. Device mounted on an FR4 printed-circuit board with copper clad 10×10 mm.
- 4. Solder point of cathode tab.

PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

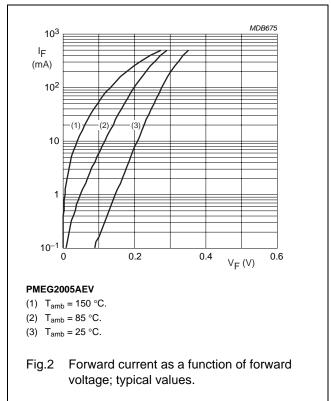
OVMDO	DADAMETED	CONDITIONS	PMEG2	005AEV	005AEV PMEG3005AE		PMEG4005AEV		
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 0.1 mA	90	130	90	130	95	130	mV
		I _F = 1 mA	150	190	150	200	155	210	mV
		I _F = 10 mA	210	240	215	250	220	270	mV
		I _F = 100 mA	280	330	285	340	295	350	mV
		I _F = 500 mA	355	390	380	430	420	470	mV
I _R	continuous reverse	V _R = 10 V; note 1	15	40	12	30	7	20	μA
	current	V _R = 20 V; note 1	40	200	_	_	_	-	μA
		V _R = 30 V; note 1	-	_	40	150	-	_	μA
		V _R = 40 V; note 1	_	_	_	_	30	100	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz	66	80	55	70	43	50	pF

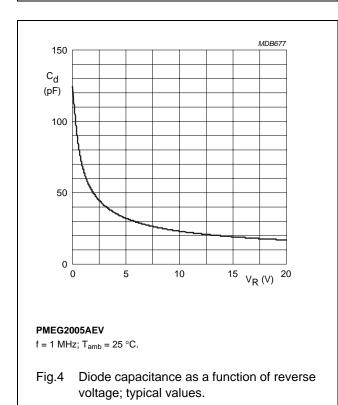
Note

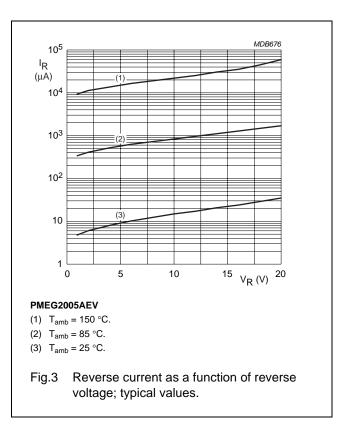
1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

GRAPHICAL DATA







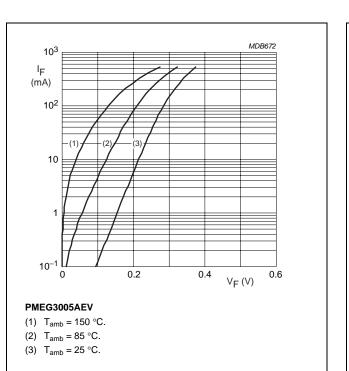
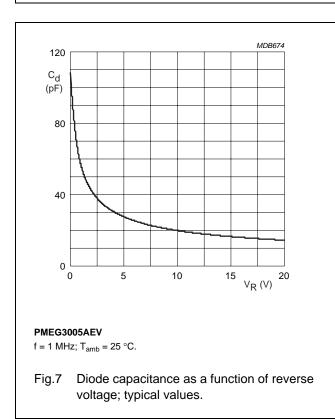
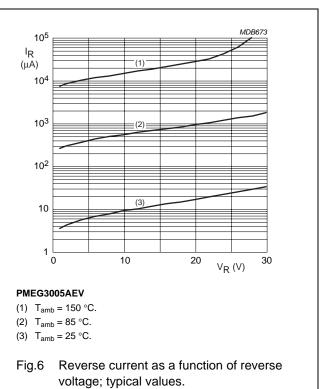
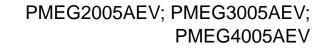


Fig.5 Forward current as a function of forward voltage; typical values.



PMEG2005AEV; PMEG3005AEV; PMEG4005AEV





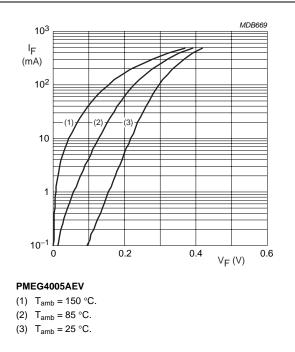
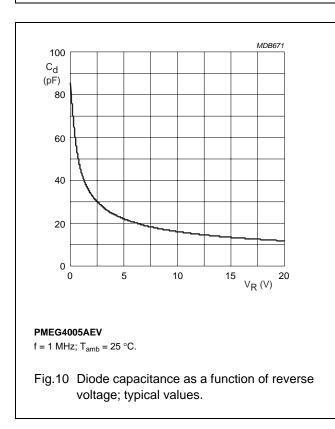


Fig.8 Forward current as a function of forward voltage; typical values.



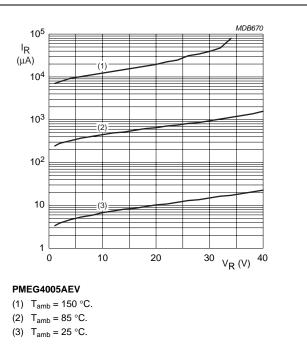
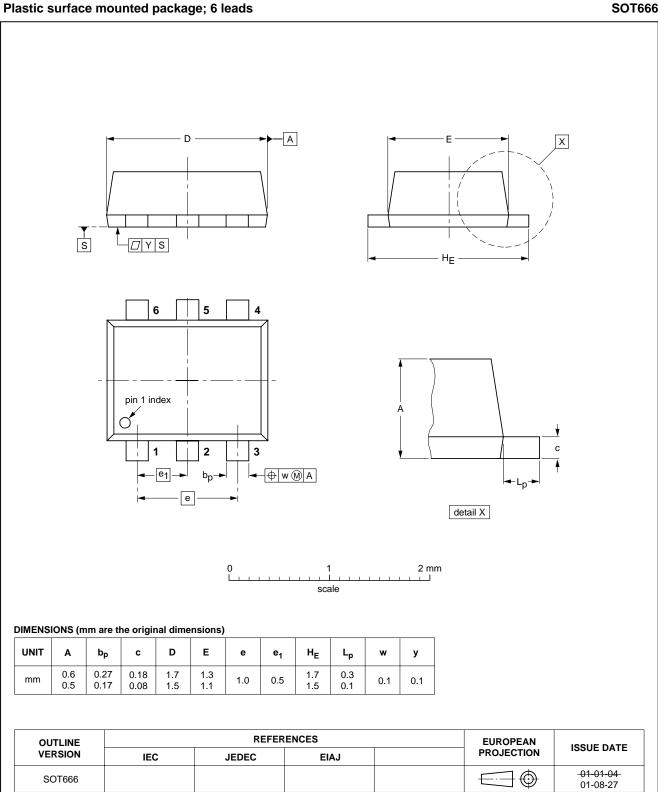


Fig.9 Reverse current as a function of reverse voltage; typical values.

PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

PACKAGE OUTLINE



SOT666

PMEG2005AEV; PMEG3005AEV; PMEG4005AEV

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

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Contact information

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